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Features

- Low dropout voltage
- Load regulation: 0.05% typical
- Trimmed current limit
- On-chip thermal limiting

-AIRCHIL

SEMICONDUCTOR®

- Standard SOT-223, TO-220, and TO-252 packages
- Three-terminal adjustable or fixed 1.8V, 2.5V, 2.85V, 3.3V, 5V

Applications

- Active SCSI terminators
- High efficiency linear regulators
- · Post regulators for switching supplies
- Battery chargers
- 12V to 5V linear regulators
- Motherboard clock supplies

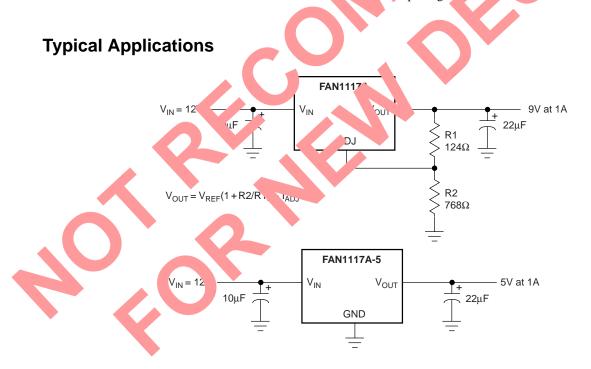
Description

The FAN1117A and FAN1117A-1.8, -2.5, -2.85, -3.3 and -5 are low dropout three-terminal regulators with 1A output current capability. These devices have been or minud for low voltage where transient response and minimum input oltage are critical. The 2.85V version is desired specifically to be used in Active Terminators for SCS out

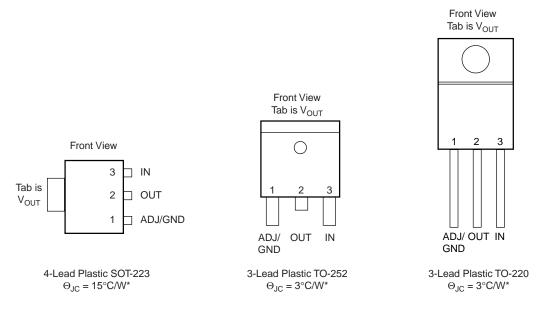
Current limit is trimmed to cour peed to output current and controlled short-circuit, trrent. The chip thermal limiting provides protection against an communation of overlained ambient temperatures that your, treate excessive unction temperatures.

Unlike PN tyr regulators where up to 10° of 2° output currer was diagraphicscent currer the autocurrent of the 1 λ 111, dows into the back preference age efficiency.

The TAL 17A series r julate are vailable in the Just standard SCT-22 JO-2 0, and TO-252 (DPAK) poor packages



Pin Assignments



*With package soldered to 0.5 square inch copper area over backside ground plane or internal power plane, Θ_{JA} can vary from 30°C/W to more than 50°C/W. Other mounting techniques may provide better thermal resistance than 30°C/W.

Absolute Maximum Ratings

Parameter	Min.	Max.	Unit
V _{IN}		18	V
(V _{IN} – V _{OUT}) * I _{OUT}		See Figure 1	
Operating Junction Temperature Range	0	125	°C
Storage Temperature Range	-65	150	°C
Lead Temperature (Soldering, 10 sec.)		300	°C

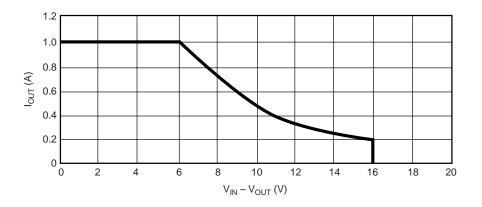


Figure 1. Absolute Maximum Safe Operating Area

Electrical Characteristics

Operating Conditions: $V_{IN} \le 7V$, $T_J = 25^{\circ}C$ unless otherwise specified. The • denotes specifications which apply over the specified operating temperature range.

Conditions Min. Units Parameter Max. Typ. $\begin{array}{l} 1.5V \leq (V_{IN} - V_{OUT}) \leq 7V, \\ 10mA \leq I_{OUT} \leq 1A \end{array} \end{array} \label{eq:VIN}$ Reference Voltage³ 1.225 1.250 1.275 V • (-2%) (+2%) Output Voltage⁴ $10mA \le I_{OUT} \le 1A$ FAN1117A-1.8, $3.3V \le V_{IN} \le 8.8V$ • 1.764 1.8 1.836 V FAN1117A-2.5, $4V \le V_{IN} \le 9.5V$ 2.450 2.550 • 2.5 V FAN1117A-2.85, $4.35V \le V_{IN} \le 9.85V$ 2.793 2.85 2.907 V • FAN1117A-3.3, $4.8V \le V_{IN} \le 10.3V$ 3.234 3.3 3.366 V FAN1117A-5, $6.5V \le V_{IN} \le 12V$ 4.900 V 5.0 5.100 • Line Regulation^{1,2} $(V_{OUT} + 1.5V) \le V_{IN} \le 12V, I_{OUT} = 10mA$ • 0.005 0.2 % Load Regulation^{1,2} $(V_{IN} - V_{OUT}) = 2V$, $10mA \le I_{OUT} \le 1A$ 0.5 % • 0.05 **Dropout Voltage** $\Delta V_{REF} = 1\%$, $I_{OUT} = 1A$ 1.100 1.200 V ٠ **Current Limit** $(V_{IN} - V_{OUT}) = 2V$ 1.5 • 1.1 А Adjust Pin Current³ • 35 120 μA $1.5V \leq (V_{IN} - V_{OUT}) \leq 7V,$ Adjust Pin Current Change^{3,4} 0.2 5 μA • $10mA \le I_{OUT} \le 1A$ $1.5V \le (V_{IN} - V_{OUT}) \le 15V$ Minimum Load Current 10 • mΑ **Quiescent Current** $V_{IN} = V_{OUT} + 1.25V$ 4 13 mΑ • **Ripple Rejection** f = 120Hz, C_{OUT} = 22µF Tantalum, 60 72 dB $(V_{IN} - V_{OUT}) = 3V, I_{OUT} = 1A$ $T_A = 25^{\circ}C$, 30ms pulse **Thermal Regulation** 0.004 0.02 %/W **Temperature Stability** 0.5 % • Long-Term Stability $T_{\Delta} = 125^{\circ}C$, 1000hrs. 0.03 1.0 % **RMS** Output Noise $T_A = 25^{\circ}C$, $10Hz \le f \le 10kHz$ 0.003 % (% of V_{OUT}) Thermal Resistance, Junction SOT-223 °C/W 15 to Case TO-252, TO-220 3 °C/W Junction Temperature Thermal Shutdown 155 °C °C Thermal Shutdown 10 Hysteresis

Notes:

1. See thermal regulation specifications for changes in output voltage due to heating effects. Load and line regulation are measured at a constant junction temperature by low duty cycle pulse testing.

 Line and load regulation are guaranteed up to the maximum power dissipation (18W). Power dissipation is determined by input/output differential and the output current. Guaranteed maximum output power will not be available over the full input/ output voltage range.

3. FAN1117A only.

4. Output current must be limited to meet the absolute maximum ratings of the part.

Typical Performance Characteristics

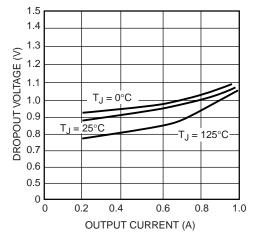


Figure 2. Dropout Voltage vs. Output Current

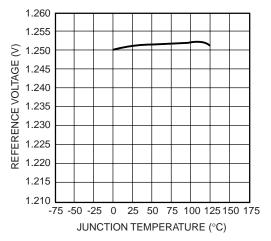


Figure 4. Reference Voltage vs. Temperature

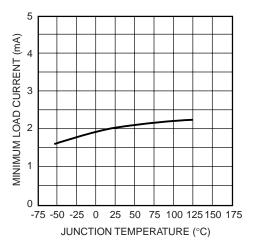


Figure 6. Minimum Load Current vs. Temperature

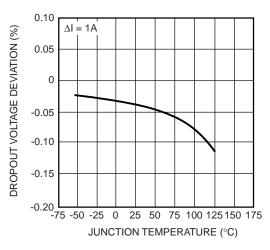


Figure 3. Load Regulation vs. Temperature

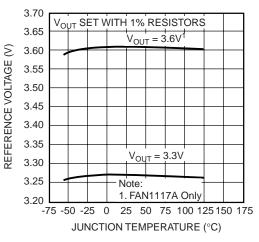


Figure 5. Output Voltage vs. Temperature

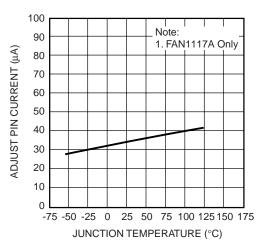


Figure 7. Adjust Pin Current vs. Temperature

Typical Performance Characteristics (continued)

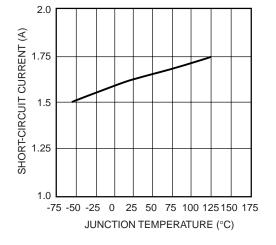


Figure 8. Short-Circuit Current vs. Temperature

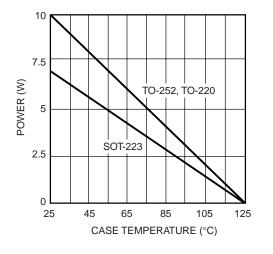


Figure 10. Maximum Power Dissipation

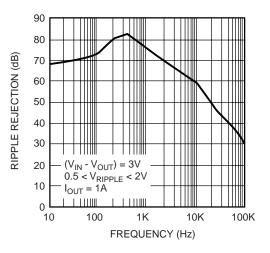


Figure 9. Ripple Rejection vs. Frequency

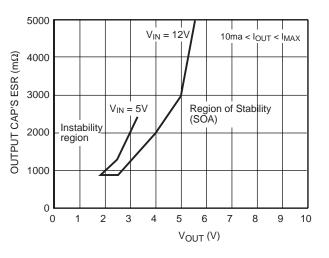
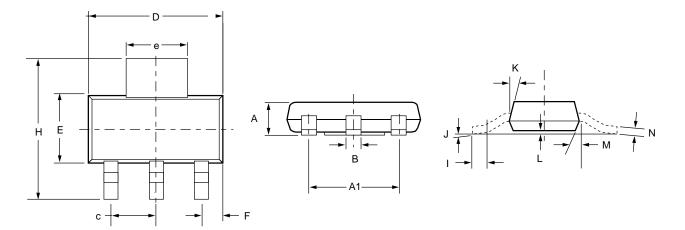


Figure 11. Stability Region (SOA) vs. ESR of the C_{OUT}

Mechanical Dimensions

4-Lead SOT-223 Package

Symbol	Inches		Millimeters		Natas
	Min.	Max.	Min.	Max.	Notes
А	_	.071	—	1.80	
A1	_	.181	_	4.80	
В	.025	.033	.640	.840	
с	_	.090	—	2.29	
D	.248	.264	6.30	6.71	
E	.130	.148	3.30	3.71	
е	.115	.124	2.95	3.15	
F	.033	.041	.840	1.04	
Н	.264	.287	6.71	7.29	
1	.012	—	.310	—	
J		10°	_	10°	
К	10°	16°	10°	16°	
L	.0008	.0040	.0203	.1018	
М	10°	16°	10°	16°	
Ν	.010	.014	.250	.360	



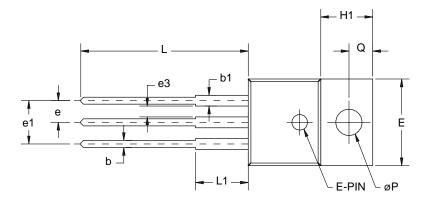
Mechanical Dimensions (continued)

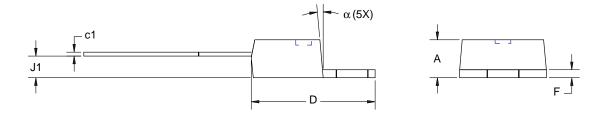
3-Lead TO-220 Package

Symbol	Inches		Millimeters		Notes
	Min.	Max.	Min.	Max.	Notes
А	.140	.190	3.56	4.83	
b	.015	.040	.38	1.02	
b1	.045	.070	1.14	1.78	
c1	.014	.022	.36	.56	
øP	.139	.161	3.53	4.09	
D	.560	.650	14.22	16.51	
E	.380	.420	9.65	10.67	
е	.090	.110	2.29	2.79	
e1	.190	.210	4.83	5.33	
e3	.045		1.14		
F	.020	.055	.51	1.40	
H1	.230	.270	5.94	6.87	
J1	.080	.115	2.04	2.92	
L	.500	.580	12.70	14.73	
L1	.250 BSC		6.35 BSC		
Q	.100	.135	2.54	3.43	
α	3°	7 °	3°	7 °	

Notes:

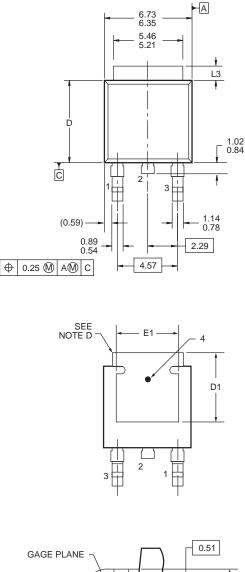
1. Dimension c1 apply for lead finish.

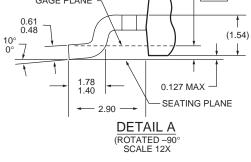


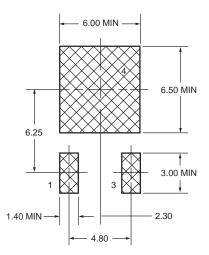


Mechanical Dimensions (continued)

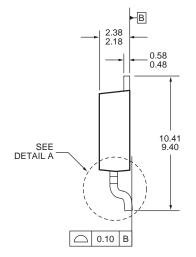
3-Lead TO-252 Package







LAND PATTERN RECOMMENDATION



NOTES: UNLESS OTHERWISE SPECIFIED

- A) ALL DIMENSIONS ARE IN MILLIMETERS.
- B) THIS PACKAGE CONFORMS TO JEDEC, TO-252, ISSUE C. VARIATION AA & AB, DATED NOV. 1999.
- C) DIMENSIONING AND TOLERANCING PER ASME Y14.5–1994.
- D) HEAT SINK TOP EDGE COULD BE IN CHAMFERED CORNERS OR EDGE PROTRUSION.
- E) DIMENSIONS L3, D, E1 & D1 TABLE:

	OPTION AA	OPTION AB
L3	0.89 - 1.27	1.52 – 2.03
D	5.97 - 6.22	5.33 - 5.59
E1	4.32 MIN	3.81 MIN
D1	5.21 MIN	4.57 MIN

Ordering Information

Product Number	Package
FAN1117ADX	TO-252 in tape and reel
FAN1117ASX	SOT-223 in tape and reel
FAN1117AD18X	TO-252 in tape and reel
FAN1117AS18X	SOT-223 in tape and reel
FAN1117AD25X	TO-252 in tape and reel
FAN1117AS25X	SOT-223 in tape and reel
FAN1117AD285	TO-252
FAN1117AS285	SOT-223
FAN1117AD33X	TO-252 in tape and reel
FAN1117AS33X	SOT-223 in tape and reel
FAN1117AT	TO-220
FAN1117AT18	TO-220
FAN1117AT25	TO-220
FAN1117AT33	TO-220
FAN1117AD5X	TO-252 in tape and reel
FAN1117AS5X	SOT-223 in tape and reel

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